



# PMEG045V150EPE

45 V, 15 A low VF Schottky barrier rectifier

15 July 2024

Product data sheet

## 1. General description

Planar Low  $V_F$  Schottky barrier rectifier encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Very low forward voltage
- High power capability due to clip-bond technology
- Small and thin SMD plastic package

## 3. Applications

- High efficiency DC-to-DC conversion
- Low voltage rectification
- Switch mode power supply
- Freewheeling application
- Reverse polarity protection
- OR-ing

## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	$\delta = 0.5$ ; $f = 20$ kHz; square wave; $T_{sp} \leq 174$ °C	-	-	15	A
$V_R$	reverse voltage	$T_j = 25$ °C	-	-	45	V
$V_F$	forward voltage	$I_F = 15$ A; pulsed; $T_j = 25$ °C	[1]	510	570	mV
$I_R$	reverse current	$V_R = 45$ V; pulsed; $T_j = 25$ °C	[1]	150	600	$\mu$ A

[1] Very short pulse, in order to maintain a stable junction temperature.

## 5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A	anode	 CFP15B (SOT1289B)	 aaa-009063
2	A	anode		
3	K	cathode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PMEG045V150EPE	CFP15B	plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body	<a href="#">SOT1289B</a>

7. Marking

Table 4. Marking codes

Type number	Marking code
PMEG045V150EPE	045V 150E

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	45	V
I <sub>F</sub>	forward current	δ = 1; T <sub>sp</sub> ≤ 173 °C		-	21	A
I <sub>F(AV)</sub>	average forward current	δ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> ≤ 174 °C		-	15	A
I <sub>FSM</sub>	non-repetitive peak forward current	t <sub>p</sub> = 8.3 ms; half sine wave; T <sub>j(init)</sub> = 25 °C		-	300	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	<a href="#">[1]</a>	-	1.66	W
			<a href="#">[2]</a>	-	2.15	W
T <sub>j</sub>	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.  
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1] [2]	-	-	90	K/W
			[1] [3]	-	-	70	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[4]	-	-	3	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Soldering point of cathode tab.

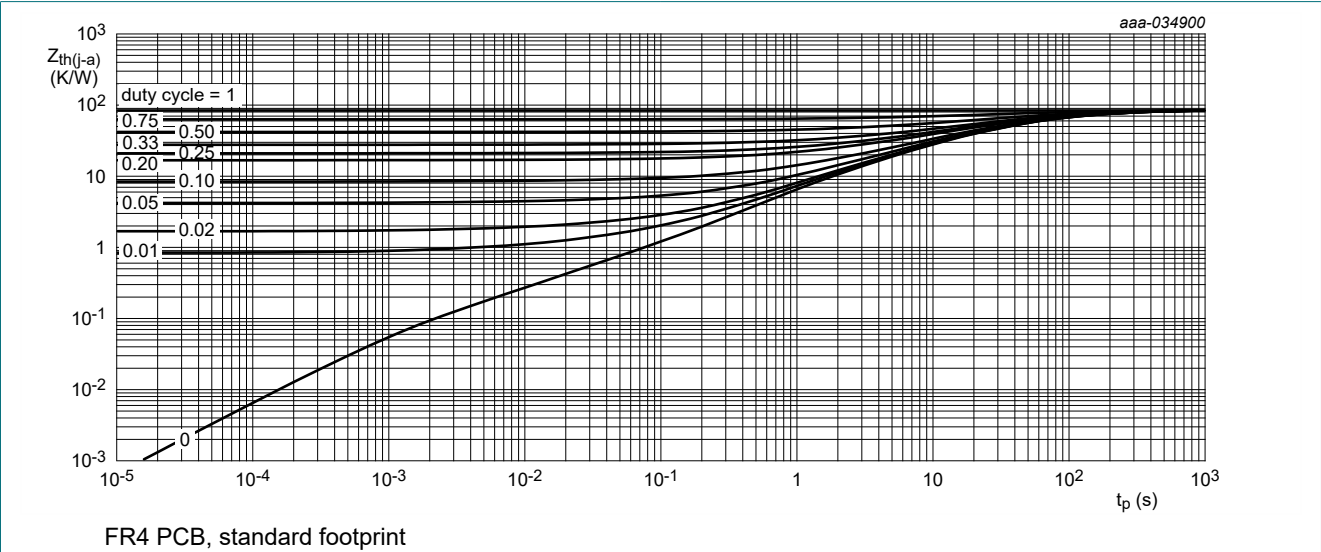


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

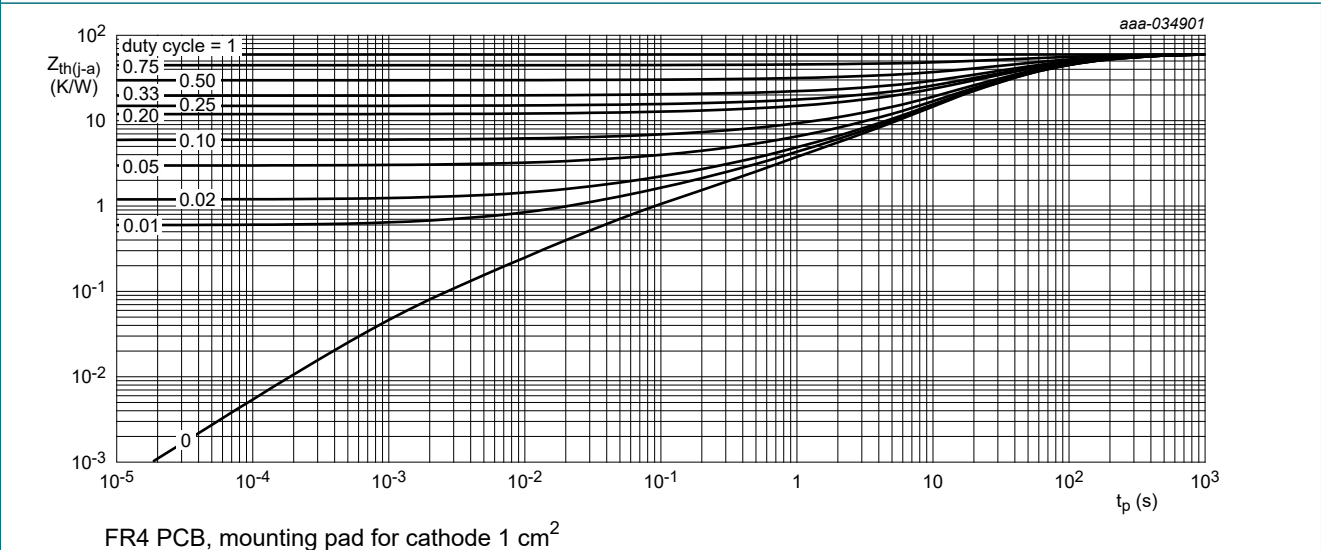


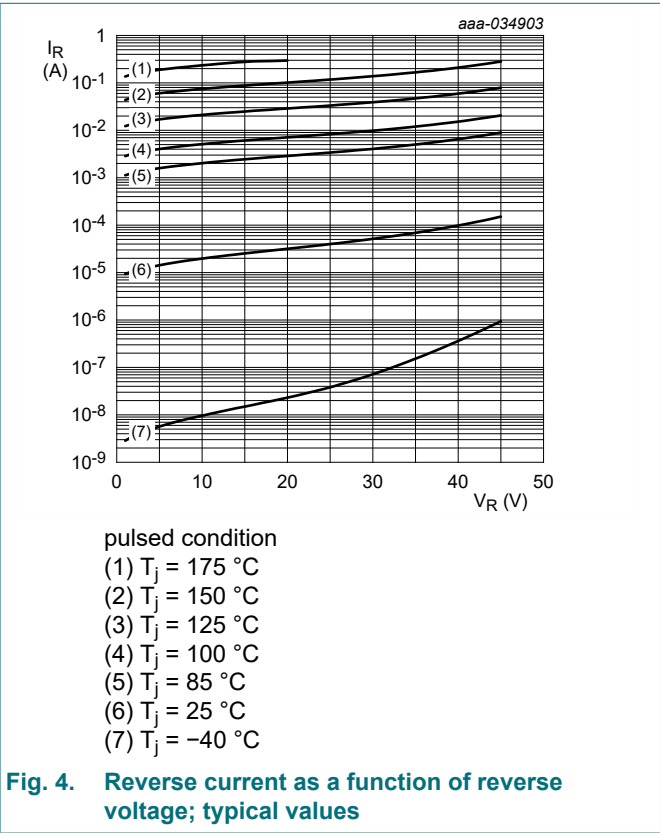
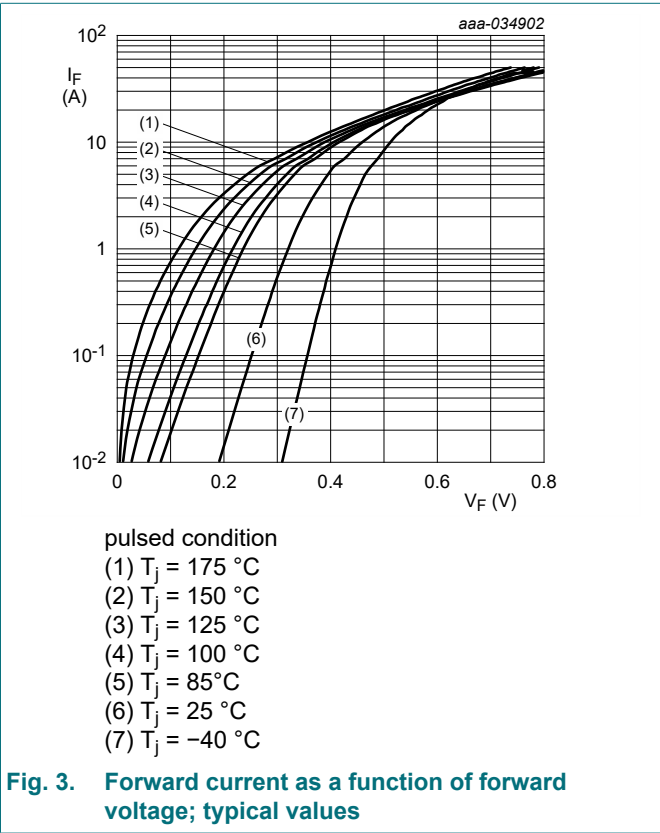
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 5\text{ mA}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	45	-	-	V
$V_F$	forward voltage	$I_F = 1\text{ A}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	-	320	360	mV
		$I_F = 5\text{ A}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	-	390	430	mV
		$I_F = 10\text{ A}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	-	450	490	mV
		$I_F = 15\text{ A}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	-	510	570	mV
		$I_F = 15\text{ A}$ ; pulsed; $T_j = -40\text{ °C}$	[1]	-	550	640	mV
		$I_F = 15\text{ A}$ ; pulsed; $T_j = 125\text{ °C}$	[1]	-	470	550	mV
$I_R$	reverse current	$V_R = 45\text{ V}$ ; pulsed; $T_j = 25\text{ °C}$	[1]	-	150	600	$\mu\text{A}$
$C_d$	diode capacitance	$V_R = 1\text{ V}$ ; $f = 1\text{ MHz}$ ; $T_j = 25\text{ °C}$		-	1140	-	pF
		$V_R = 10\text{ V}$ ; $f = 1\text{ MHz}$ ; $T_j = 25\text{ °C}$		-	375	-	pF
$t_{rr}$	reverse recovery time step recovery	$I_F = 0.5\text{ A}$ ; $I_R = 0.5\text{ A}$ ; $I_{R(meas)} = 0.1\text{ A}$ ; $T_j = 25\text{ °C}$		-	36	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 100\text{ A}/\mu\text{s}$ ; $I_F = 3\text{ A}$ ; $V_R = 30\text{ V}$ ; $T_j = 25\text{ °C}$		-	19	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5\text{ A}$ ; $dI_F/dt = 20\text{ A}/\mu\text{s}$ ; $T_j = 25\text{ °C}$		-	290	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.



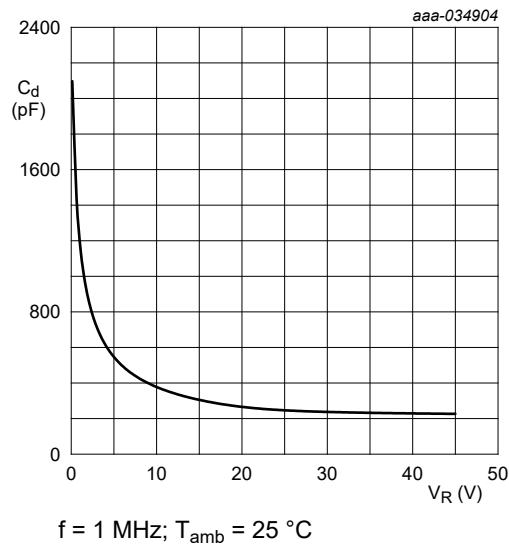


Fig. 5. Diode capacitance as a function of reverse voltage; typical values

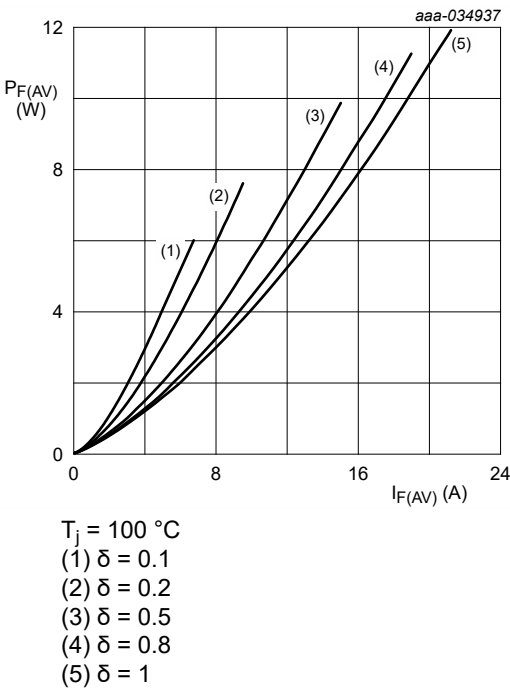


Fig. 6. Average forward power dissipation as a function of average forward current; typical values

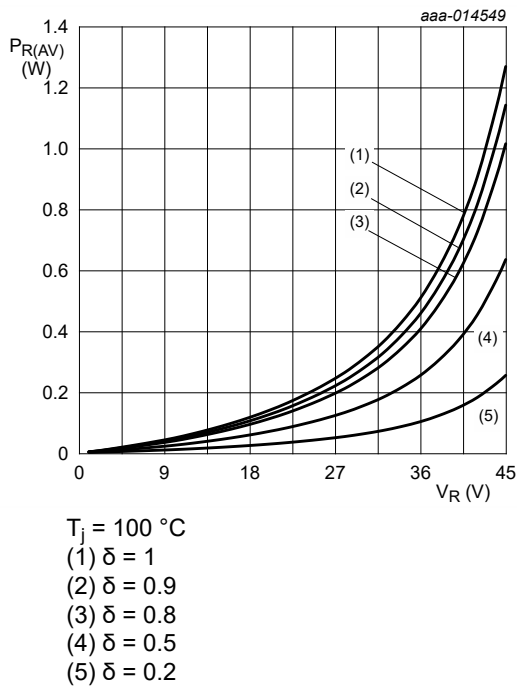


Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values

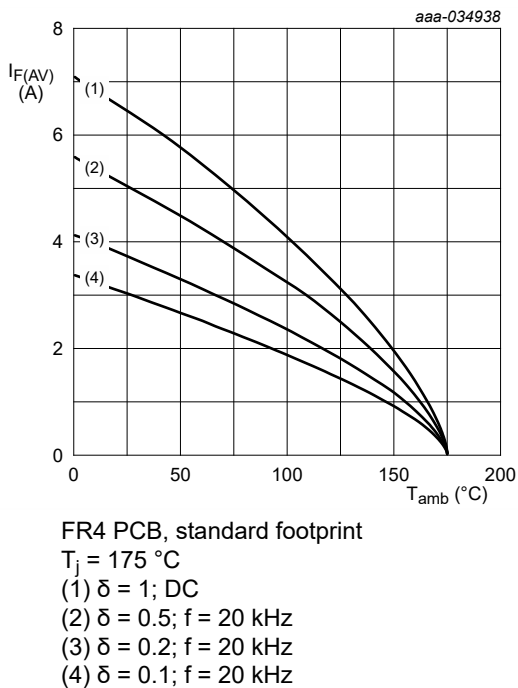
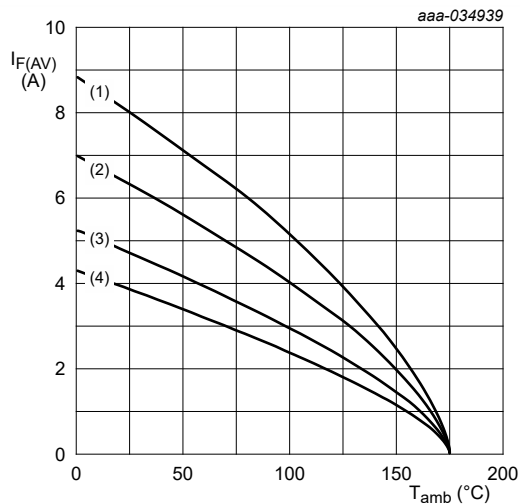
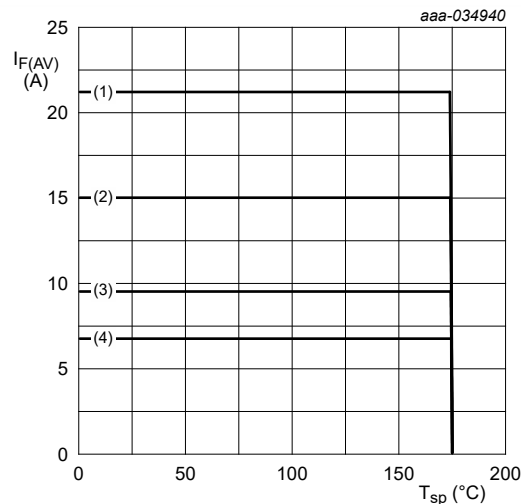


Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>  
 $T_j = 175$  °C  
(1)  $\delta = 1$ ; DC  
(2)  $\delta = 0.5$ ;  $f = 20$  kHz  
(3)  $\delta = 0.2$ ;  $f = 20$  kHz  
(4)  $\delta = 0.1$ ;  $f = 20$  kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



$T_j = 175$  °C  
(1)  $\delta = 1$ ; DC  
(2)  $\delta = 0.5$ ;  $f = 20$  kHz  
(3)  $\delta = 0.2$ ;  $f = 20$  kHz  
(4)  $\delta = 0.1$ ;  $f = 20$  kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

11. Test information

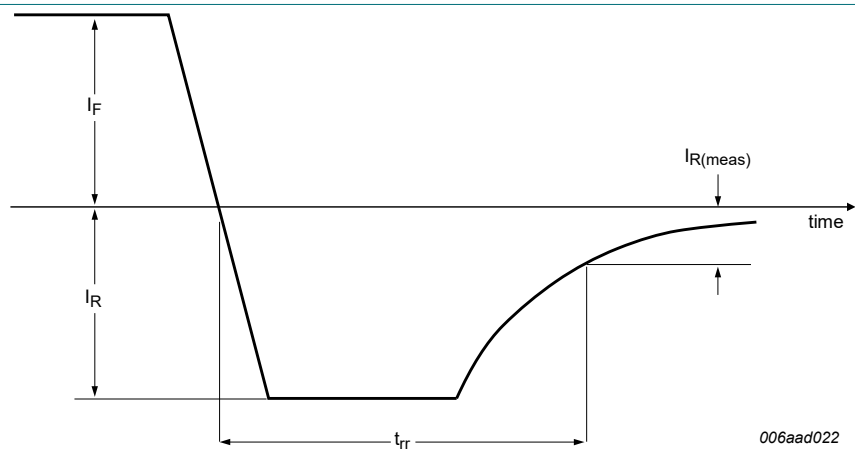


Fig. 11. Reverse recovery definition; step recovery

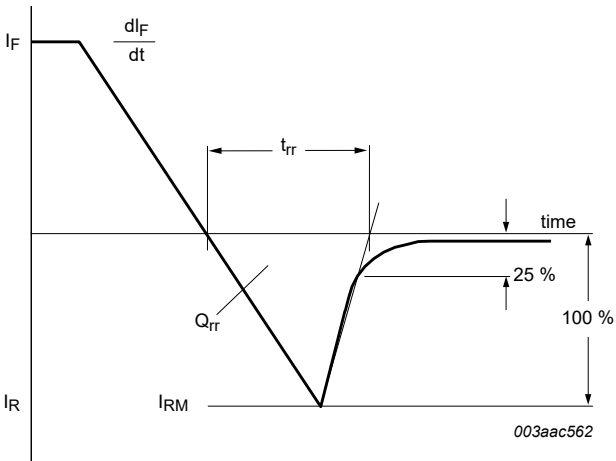


Fig. 12. Reverse recovery definition; ramp recovery

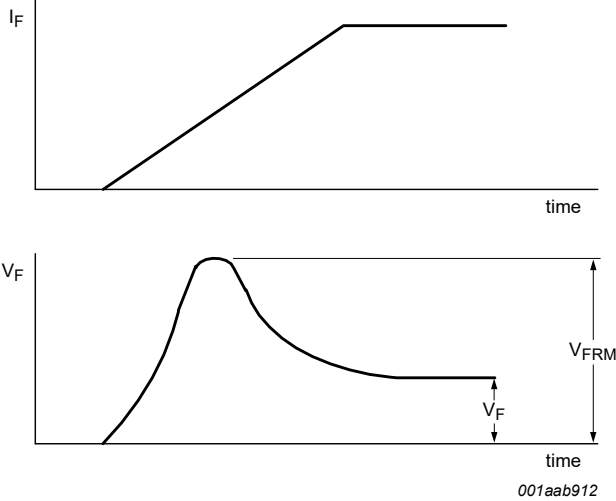


Fig. 13. Forward recovery definition

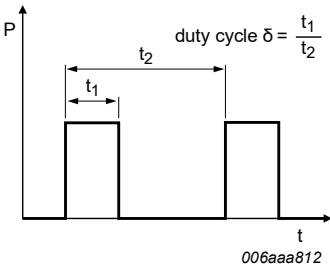


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current

$I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{\delta}$

with  $I_{RMS}$  defined as RMS current.

12. Package outline

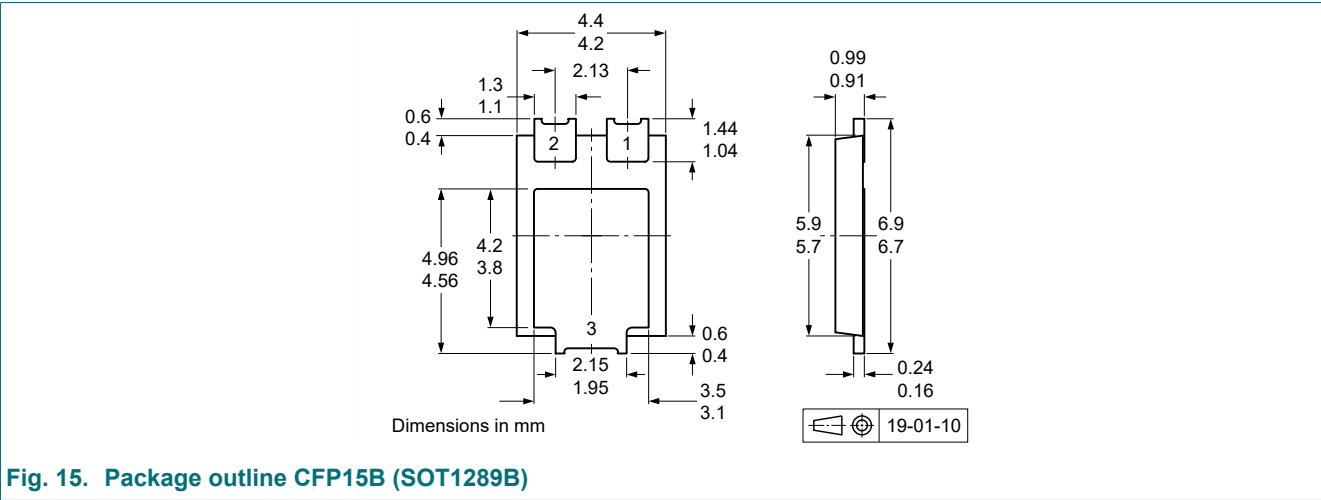
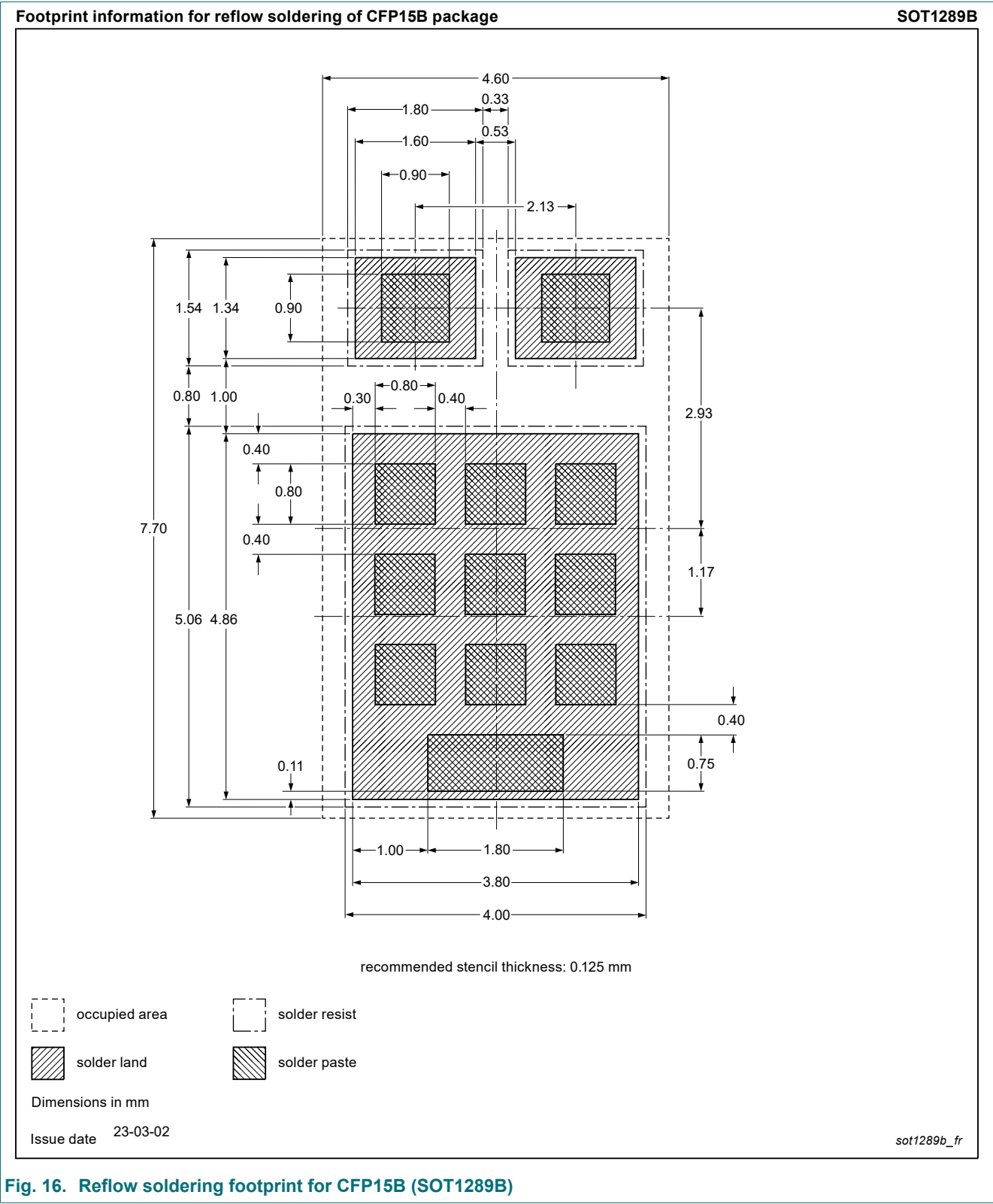


Fig. 15. Package outline CFP15B (SOT1289B)



13. Soldering



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PMEG045V150EPE v.3	20240715	Product data sheet	-	PMEG045V150EPE v.2
Modifications:	• Reflow soldering footprint: Stencil design for solder paste printing changed.			
PMEG045V150EPE v.2	20220720	Product data sheet	-	PMEG045V150EPE v.1
PMEG045V150EPE v.1	20220519	Preliminary data sheet	-	-

## 15. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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